imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Self-Protected FET with Temperature and Current Limit

HDPlus devices are an advanced series of power MOSFETs which utilize ON Semicondutor's latest MOSFET technology process to achieve the lowest possible on-resistance per silicon area while incorporating smart features. Integrated thermal and current limits work together to provide short circuit protection. The devices feature an integrated Drain-to-Gate Clamp that enables them to withstand high energy in the avalanche mode. The Clamp also provides additional safety margin against unexpected voltage transients. Electrostatic Discharge (ESD) protection is provided by an integrated Gate-to-Source Clamp.

Features

- Low R_{DS(on)}
- Current Limitation
- Thermal Shutdown with Automatic Restart
- Short Circuit Protection
- I_{DSS} Specified at Elevated Temperature
- Avalanche Energy Specified
- Slew Rate Control for Low Noise Switching
- Overvoltage Clamped Protection
- Pb–Free Package is Available

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit			
Drain-to-Source Voltage Internally Clamped	V _{DSS}	42	Vdc			
Drain-to-Gate Voltage Internally Clamped $(R_{GS} = 1.0 \text{ M}\Omega)$	V _{DGR}	42	Vdc			
Gate-to-Source Voltage	V _{GS}	±14	Vdc			
Drain Current – Continuous	I _D	Internally Limited				
Total Power Dissipation @ $T_A = 25^{\circ}C$ (Note 1) @ $T_A = 25^{\circ}C$ (Note 1) @ $T_A = 25^{\circ}C$ (Note 2)	PD	64 1.0 1.56	W			
Thermal Resistance, Junction-to-Case Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	$f{R}_{ heta JC} \ f{R}_{ heta JA} \ f{R}_{ heta JA}$	1.95 120 80	°C/W			
$ Single Pulse Drain-to-Source Avalanche Energy \\ (V_{DD} = 25 Vdc, V_{GS} = 5.0 Vdc, \\ I_L = 4.5 Apk, L = 120 mH, R_G = 25 \Omega) $	E _{AS}	1215	mJ			
Operating and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C			

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Minimum FR4 PCB, steady state.

2. Mounted onto a 2" square FR4 board

(1" square, 2 oz. Cu 0.06" thick single-sided, t = steady state).

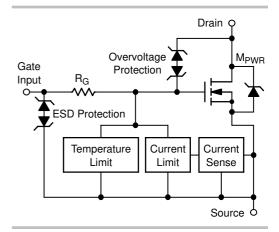


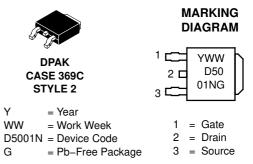
ON Semiconductor®

http://onsemi.com

V _{DSS} (Clamped)	R _{DS(ON)} TYP	I _D MAX (Limited)
42 V	23 mΩ @ 10 V	33 A*

*Max current may be limited below this value depending on input conditions.





ORDERING INFORMATION

Device	Package	Shipping [†]
NID5001NT4	DPAK	2500/Tape & Reel
NID5001NT4G	DPAK (Pb–Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

CI	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS			•	•	•	•
$\begin{array}{l} \mbox{Drain-to-Source Clamped Breakc} \\ (V_{GS}=0 \mbox{ Vdc}, I_D=250 \mu \mbox{Adc}) \\ (V_{GS}=0 \mbox{ Vdc}, I_D=250 \mu \mbox{Adc}, 1 \end{array}$	V _{(BR)DSS}	42 42	46 44	50 50	Vdc	
Zero Gate Voltage Drain Current (V_{DS} = 32 Vdc, V_{GS} = 0 Vdc) (V_{DS} = 32 Vdc, V_{GS} = 0 Vdc, T	I _{DSS}		1.5 6.5	5.0	μAdc	
Gate Input Current $(V_{GS} = 5.0 \text{ Vdc}, V_{DS} = 0 \text{ Vdc})$	I _{GSSF}		50	100	μAdc	
ON CHARACTERISTICS						
Gate Threshold Voltage $(V_{DS} = V_{GS}, I_D = 1.2 \text{ mAdc})$ Threshold Temperature Coeffic	V _{GS(th)}	1.0	1.8 5.0	2.0	Vdc _mV/°C	
$\begin{array}{l} \mbox{Static Drain-to-Source On-Resis} \\ (V_{GS} = 10 \mbox{ Vdc}, I_D = 5.0 \mbox{ Adc}, T \\ (V_{GS} = 10 \mbox{ Vdc}, I_D = 5.0 \mbox{ Adc}, T \end{array}$	R _{DS(on)}		23 43	29 55	mΩ	
$\begin{array}{l} \mbox{Static Drain-to-Source On-Resis} \\ (V_{GS}=5.0 \mbox{ Vdc}, \mbox{ I}_{D}=5.0 \mbox{ Adc}, \mbox{ I} \\ (V_{GS}=5.0 \mbox{ Vdc}, \mbox{ I}_{D}=5.0 \mbox{ Adc}, \mbox{ I} \end{array}$	R _{DS(on)}		28 50	34 60	mΩ	
Source–Drain Forward On Voltage $(I_S = 5 \text{ A}, V_{GS} = 0 \text{ V})$	V _{SD}		0.80	1.1	V	
SWITCHING CHARACTERISTICS	;					
Turn–on Time	$V_{GS} = 5.0 V_{dc}, V_{DD} = 25 V_{dc}$	T _(on)		32	40	μs
Turn-off Time	$I_D = 1.0 A_{dc}$, Ext $R_G = 2.5 \Omega$	T _(off)		68	75	
Turn–on Time	$V_{GS} = 10 V_{dc}, V_{DD} = 25 V_{dc}$	T _(on)		11	15	
Turn-off Time	$I_D = 1.0 A_{dc}$, Ext $R_G = 2.5 \Omega$	T _(off)		86	95	
Slew Rate On	$R_L = 4.7 \Omega,$ V _{in} = 0 to 10 V, V _{DD} = 12 V	-dV _{DS} /dt _{on}		0.5		V/µs
Slew-Rate Off	$R_L = 4.7 \Omega,$ $V_{in} = 10 \text{ to } 0 \text{ V}, \text{ V}_{DD} = 12 \text{ V}$	dV _{DS} /dt _{off}		0.35		V/µs
SELF PROTECTION CHARACTE	RISTICS (T _J = 25° C unless otherwise noted)		•	•	•	
Current Limit	$(V_{GS} = 5.0 \text{ Vdc}) \\ V_{DS} = 10 \text{ V} (V_{GS} = 5.0 \text{ Vdc}, \text{T}_{\text{J}} = 150^{\circ}\text{C}) \\$	I _{LIM}	21 12	30 19	36 30	Adc
	$(V_{GS} = 10 \text{ Vdc})$ $V_{DS} = 10 \text{ V} (V_{GS} = 10 \text{ Vdc}, T_J = 150^{\circ}\text{C})$		29 13	41 24	49 31	
Temperature Limit (Turn-off)	$V_{GS} = 5.0 \text{ Vdc}$	T _{LIM(off)}	150	175	200	°C
Temperature Limit (Circuit Reset)			135	160	185	°C
Temperature Limit (Turn-off)	V _{GS} = 10 Vdc	T _{LIM(off)}	150	165	185	°C
Temperature Limit (Circuit Reset)	V _{GS} = 10 Vdc	T _{LIM(on)}	135	150	170	°C
ESD ELECTRICAL CHARACTER	ISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)					
Electro-Static Discharge Capabilit		ESD	4000			V

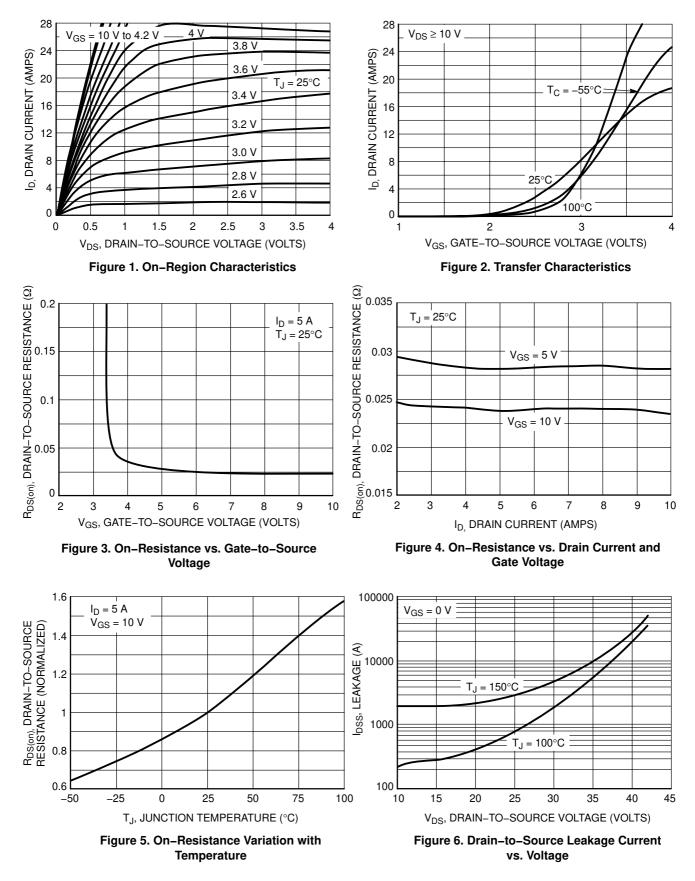
 Electro-Static Discharge Capability
 ESD

 Human Body Model (HBM)
 4000

 Machine Model (MM)
 400

3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES

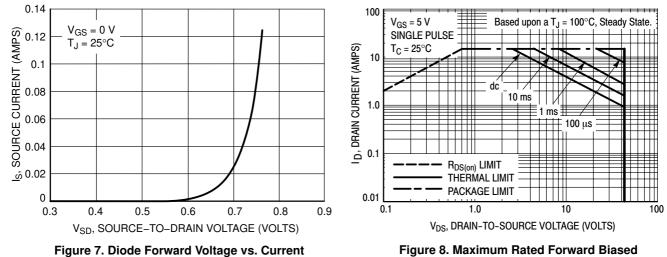
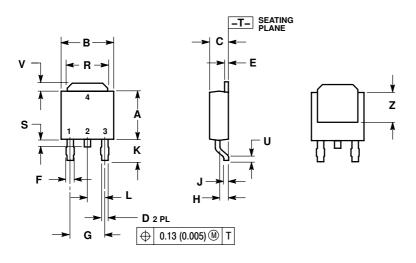


Figure 8. Maximum Rated Forward Biased Safe Operating Area

PACKAGE DIMENSIONS

DPAK CASE 369C-01 ISSUE O



NOTES:

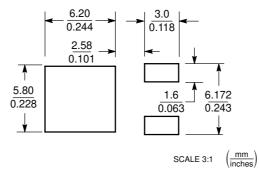
DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIN	IETERS		
DIM	MIN	MAX	MIN	MAX		
Α	0.235	0.245	5.97	6.22		
В	0.250	0.265	6.35	6.73		
С	0.086	0.094	2.19	2.38		
D	0.027	0.035	0.69	0.88		
Е	0.018	3 0.023 0.46		0.58		
F	0.037	0.045	0.94	1.14		
G	0.180	BSC	4.58	BSC		
Н	0.034	0.040	0.87	1.01		
J	0.018	0.023	0.46	0.58		
Κ	0.102	0.114	2.60	2.89		
L	0.090	0.090 BSC 2.29 BS		BSC		
R	0.180	0.215	4.57	5.45		
S	0.025	0.040	0.63	1.01		
U	0.020		0.51			
٧	0.035	0.050	0.89	1.27		
Z	0.155		3.93			

STYLE 2: PIN 1. GATE 2. DRAIN

SOURCE DRAIN

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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